# APPROVAL SHEET



CUSTOMER NAME	:_	
COMMODITY	:_	MAGNETIC TRANSDUCER
FHD PART NO.	•	T858540-M2700Z-SH
CUSTOMER PART NO.	:	
	_	

Customer Approval					
Approved	Rejected				

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Email: <a href="mailto:sales@fhdmfg.com">sales@fhdmfg.com</a> Website: <a href="www.fhdmfg.com">www.fhdmfg.com</a>

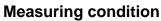


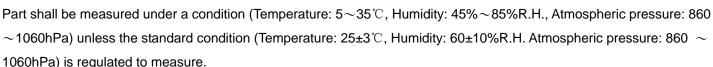
### **REVISIONS**

DATE	REVISER	REV.	DESCRIPTION	REMARK
2021/3/19	HY SHEN	1	Initial edition	

### A. PART NO.: T858540-M2700Z-SH

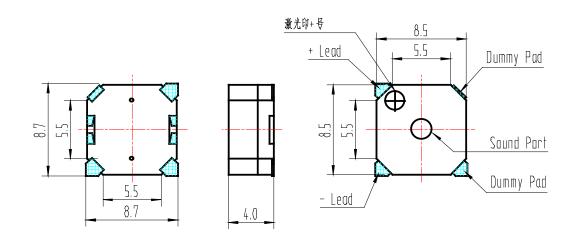
### **B. SPECIFICATION**





No.	Item	Unit	Specification	Condition
1	Oscillation Frequency	Hz	2700	square wave
2	Operating Voltage	Vo-p	2.5 ~ 4.5	
3	Rated Voltage	Vo-p	3.6	
4	Coil Resistance	Ω	16±3	
5	Current Consumption	mA	MAX. 100	At 2700Hz 50% duty Square Wave 3.6Vo-p
6	Sound Pressure Level	dB	MIN. 85	At 2700Hz 50% duty Square Wave 3.6Vo-p @ 10cm
7	Operating Temperature	$^{\circ}\!\mathbb{C}$	-20 ~ +70	
8	Storage Temperature	$^{\circ}\!\mathbb{C}$	-40 ~ +85	
9	Dimension	mm	8.5x8.5x4.0	See appearance drawing
10	Weight (MAX)	gram	0.4	
11	Housing Material		LCP ( Black )	
12	Connection		SMD (Tin Plated Brass)	See appearance drawing
13	Environmental Protection Regulation		RoHS	

# C. APPEARANCE DRAWING



Tolerance: ± 0.3mm Except Specified

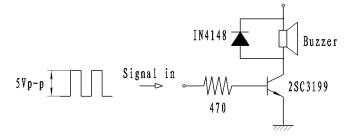
Terminal plate: 3 soldering pads, Tin Plating Brass

### D. ELECTRICAL AND ACOUSTICAL MEASURING CONDITION

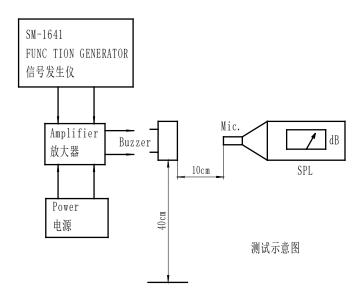
### **Recommended Driving Circuit:**

Resonant frequency, 1/2 duty cycle. Square Wave.

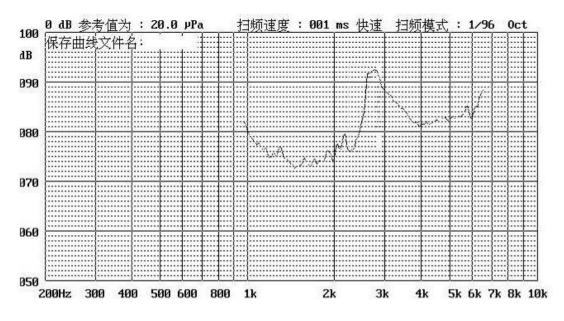
Signal amplitude should be large enough to saturate the transistor.



#### **Recommended Setting:**



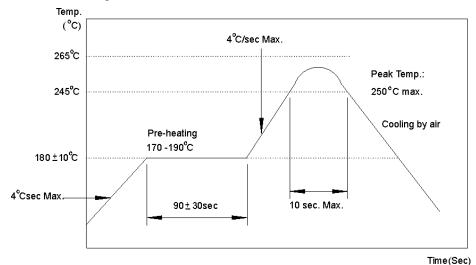
### E. TYPICAL FREQUENCY RESPONSE CURVE



3.6Vo-p 50% duty square wave, 10cm

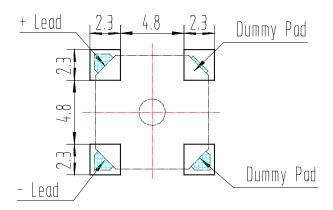
### F. SURFACE MOUNTING CONDITION

1. Recommendable reflow soldering condition is as follows

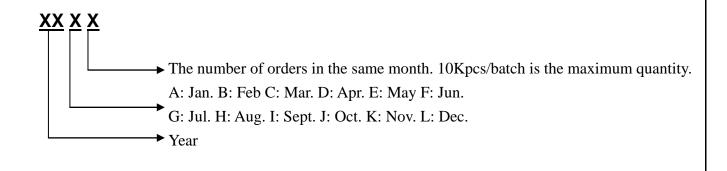


- **Note:** (1) In automated mounting of the SMD sound transducers on PCB, any bending, expanding and pulling forces or shocks against the SMD sound transducers shall be kept minimum to prevent them from electrical failures and mechanical damages of the devices.
  - (2) In the reflow soldering, too high soldering temperatures and too large temperature gradient such as rapid heating or cooling may cause electrical failures and mechanical damages of the devices.

### 2. Soldering Pattern



### G. LOT NUMBER NOMINATION



### H. RELIABILITY TEST

After any following tests the part shall meet specifications without any degradation in appearance and performance except SPL. SPL shall not deviate more than -10 Db from the initial value

### 1. Ordinary Temperature Life Test

The part shall be subjected to 96 hours at 25±10℃. Input rated voltage Resonant frequency, 1/2 duty Square wave.

### 2. High Temperature Test

The part shall be capable of withstanding a storage temperature of +85℃ for 96 hours.

#### 3. Low Temperature Test

The part shall be capable of withstanding a storage temperature of -40 $^{\circ}$ C for 96 hours.

#### 4. Humidity Test

Temperature:+40  $^{\circ}$ C±3  $^{\circ}$ C Relative Humidity:90% $^{\circ}$ 95% Duration: 48 hours and expose to room temperature for 6 hours

#### 5. Temperature Shock Test

Temperature:60  $^{\circ}$ C /1hour  $\rightarrow$  25  $^{\circ}$ C/3hours  $\rightarrow$ -20  $^{\circ}$ C/1hour  $\rightarrow$  25  $^{\circ}$ C/3hours (1cycle)

Total cycle: 10 cycles

#### 6. Drop Test

Standard Packaging From 75cm(Drop on hard wood or board of 5cm thick, three sides, six plain.)

#### 7. Vibration Test

Vibration: 1000cycles /min. Amplitude:1.5mm, Duration: 1 hour in each 3 axes

#### 8. Reflow Test

Use recommendable reflow soldering condition (as shown in F.1)

- (1) No abnormality should be found after reflow
- (2) Good soldering to meet soldering requirements

#### Note:

As this product is not protected from foreign material entering, please make sure that any foreign materials (e.g. magnetic powder, washing solvent, flux, corrosive gas) do not enter this product in your production processes. The functional degradation (e.g. SPL down) may occur if foreign materials enter it.

## I. PACKING INFORMATION

